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SEMICONDUCTOR®

**QFET™**

FQP8N80C/FQPF8N80C

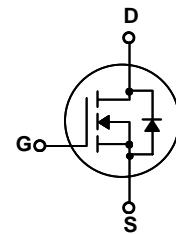
## FQP8N80C/FQPF8N80C 800V N-Channel MOSFET

### General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies.

### Features

- 8A, 800V,  $R_{DS(on)} = 1.55\Omega$  @  $V_{GS} = 10$  V
- Low gate charge ( typical 35 nC)
- Low  $C_{RSS}$  ( typical 13 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



### Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	FQP8N80C	FQPF8N80C	Units
$V_{DSS}$	Drain-Source Voltage	800		V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ )	8	8 *	A
	- Continuous ( $T_C = 100^\circ\text{C}$ )	5.1	5.1 *	A
$I_{DM}$	Drain Current - Pulsed	(Note 1)	32	A
$V_{GSS}$	Gate-Source Voltage		$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy	(Note 2)	850	mJ
$I_{AR}$	Avalanche Current	(Note 1)	8	A
$E_{AR}$	Repetitive Avalanche Energy	(Note 1)	17.8	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$	(Note 3)	4.5	V/ns
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	178	59	W
	- Derate above $25^\circ\text{C}$	1.43	0.48	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	$^\circ\text{C}$

\* Drain current limited by maximum junction temperature.

### Thermal Characteristics

Symbol	Parameter	FQP8N80C	FQPF8N80C	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.7	2.1	$^\circ\text{C}/\text{W}$
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	--	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	$^\circ\text{C}/\text{W}$



FQP8N80C/FQPF8N80C

**Electrical Characteristics** $T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	800	--	--	V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.5	--	$^\circ\text{C}$
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 800 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$	--	--	10	$\mu\text{A}$
		$V_{\text{DS}} = 640 \text{ V}$ , $T_C = 125^\circ\text{C}$	--	--	100	$\mu\text{A}$
$I_{\text{GSSF}}$	Gate-Body Leakage Current, Forward	$V_{\text{GS}} = 30 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$	--	--	100	nA
$I_{\text{GSSR}}$	Gate-Body Leakage Current, Reverse	$V_{\text{GS}} = -30 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$	--	--	-100	nA

**On Characteristics**

$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 250 \mu\text{A}$	3.0	--	5.0	V
$R_{\text{DS}(\text{on})}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 10 \text{ V}$ , $I_D = 4 \text{ A}$	--	1.29	1.55	$\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = 50 \text{ V}$ , $I_D = 4 \text{ A}$ (Note 4)	--	5.6	--	S

**Dynamic Characteristics**

$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 25 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$ , $f = 1.0 \text{ MHz}$	--	1580	2050	pF
$C_{\text{oss}}$	Output Capacitance		--	135	175	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	13	17	pF

**Switching Characteristics**

$t_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DD}} = 400 \text{ V}$ , $I_D = 8 \text{ A}$ , $R_G = 25 \Omega$	--	40	90	ns
$t_r$	Turn-On Rise Time		--	110	230	ns
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time		--	65	140	ns
$t_f$	Turn-Off Fall Time		--	70	150	ns
$Q_g$	Total Gate Charge	$V_{\text{DS}} = 640 \text{ V}$ , $I_D = 8 \text{ A}$ , $V_{\text{GS}} = 10 \text{ V}$	--	35	45	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	10	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	14	--	nC
			(Note 4, 5)			

**Drain-Source Diode Characteristics and Maximum Ratings**

$I_S$	Maximum Continuous Drain-Source Diode Forward Current	--	--	8	A	
$I_{\text{SM}}$	Maximum Pulsed Drain-Source Diode Forward Current	--	--	32	A	
$V_{\text{SD}}$	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_S = 8 \text{ A}$	--	--	1.4	V
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{GS}} = 0 \text{ V}$ , $I_S = 8 \text{ A}$	--	690	--	ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$dI_F / dt = 100 \text{ A}/\mu\text{s}$	(Note 4)	--	8.2	$\mu\text{C}$

**Notes:**

1. Repetitive Rating : Pulse width limited by maximum junction temperature

2.  $L = 25\text{mH}$ ,  $I_{AS} = 8\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25^\circ\text{C}$ 3.  $I_{SD} \leq 8\text{A}$ ,  $dI/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq \text{BV}_{\text{DSS}}$ , Starting  $T_J = 25^\circ\text{C}$ 4. Pulse Test : Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ 

5. Essentially independent of operating temperature



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## Typical Characteristics

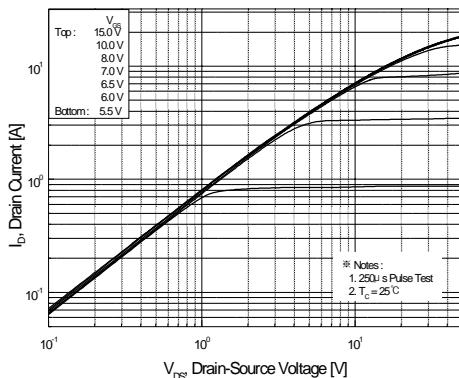


Figure 1. On-Region Characteristics

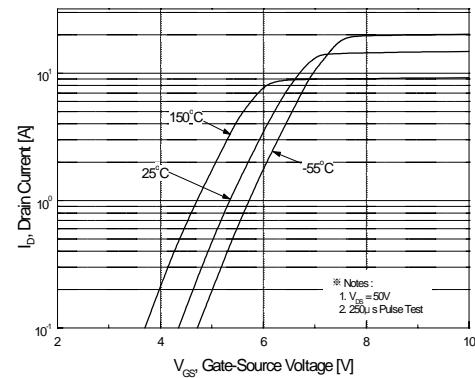


Figure 2. Transfer Characteristics

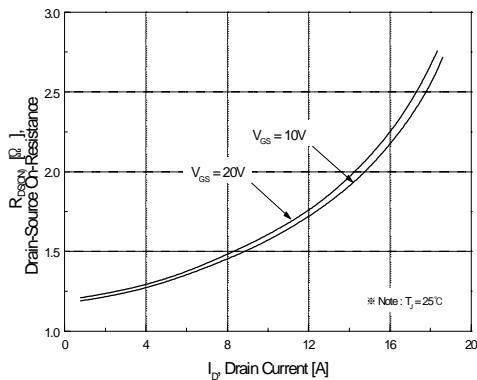


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

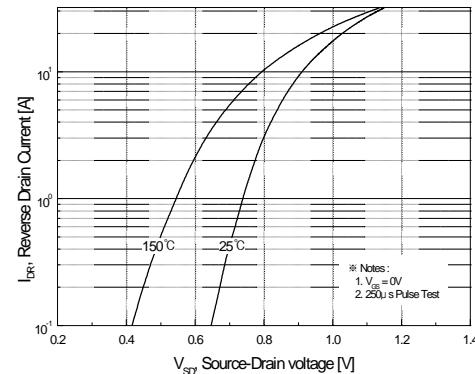


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

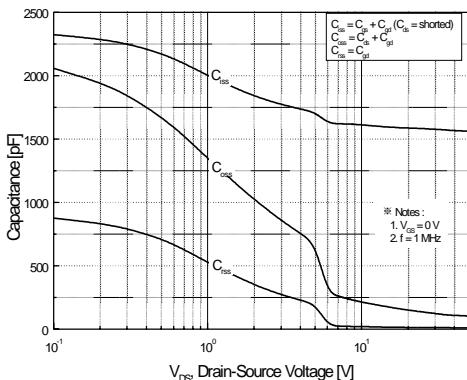


Figure 5. Capacitance Characteristics

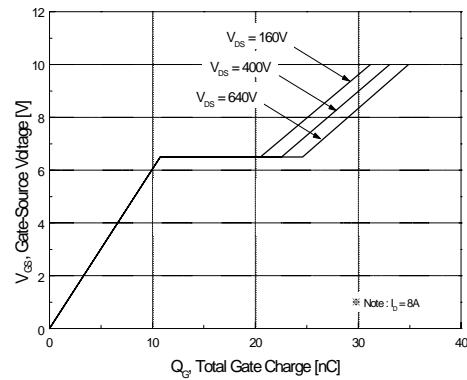


Figure 6. Gate Charge Characteristics



## Typical Characteristics (Continued)

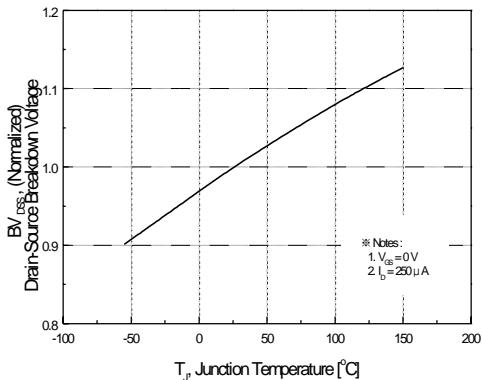


Figure 7. Breakdown Voltage Variation  
vs Temperature

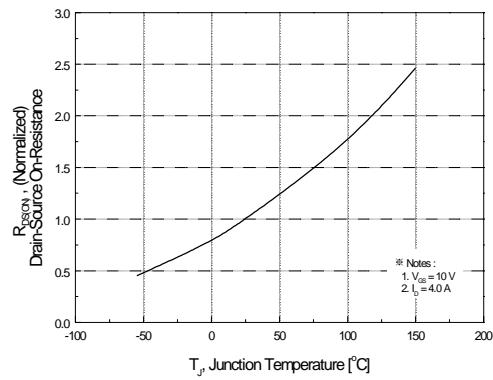


Figure 8. On-Resistance Variation  
vs Temperature

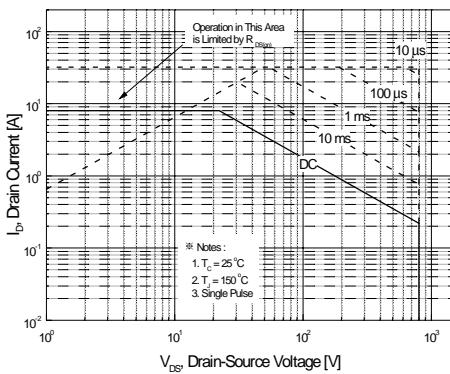


Figure 9-1. Maximum Safe Operating Area  
for FQPF8N80C

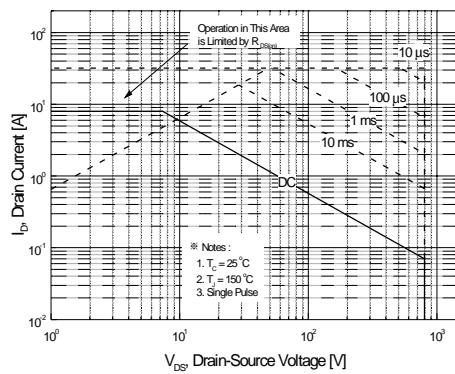


Figure 9-2. Maximum Safe Operating Area  
for FQPF8N80C

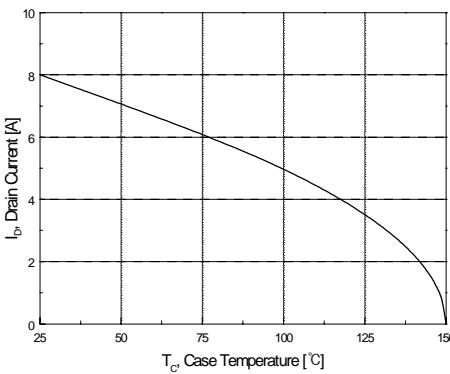


Figure 10. Maximum Drain Current  
vs Case Temperature



## Typical Characteristics (Continued)

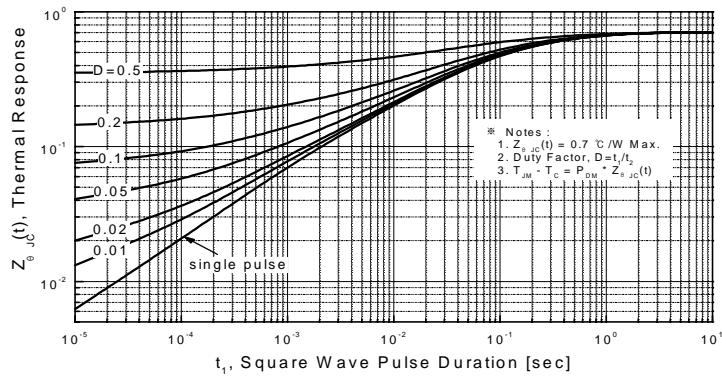


Figure 11-1. Transient Thermal Response Curve for FQP8N80C

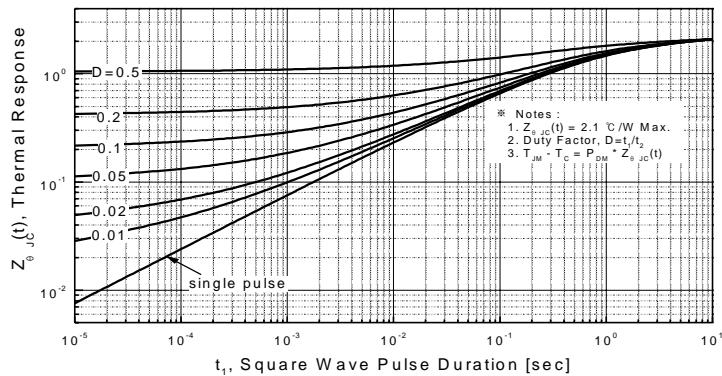


Figure 11-2. Transient Thermal Response Curve for FQPF8N80C



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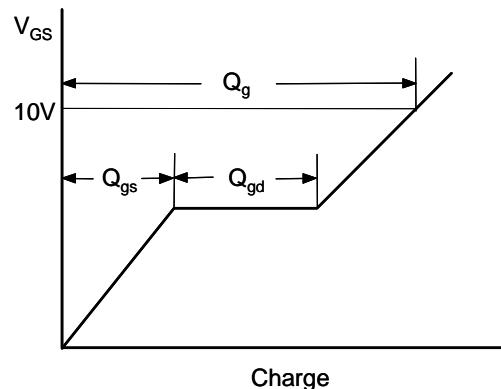
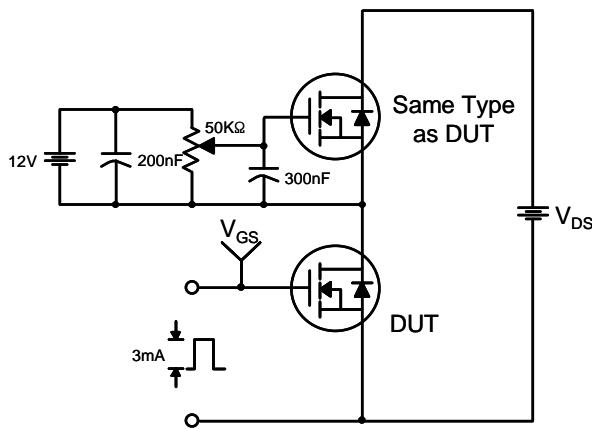
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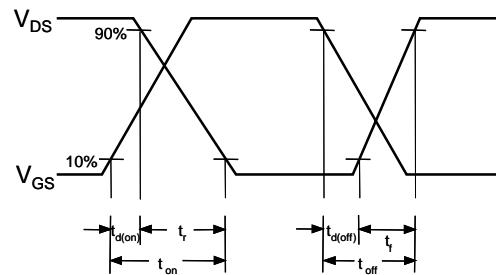
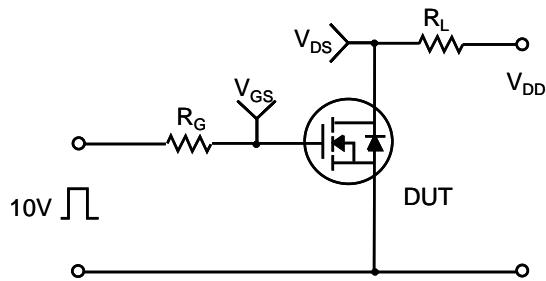
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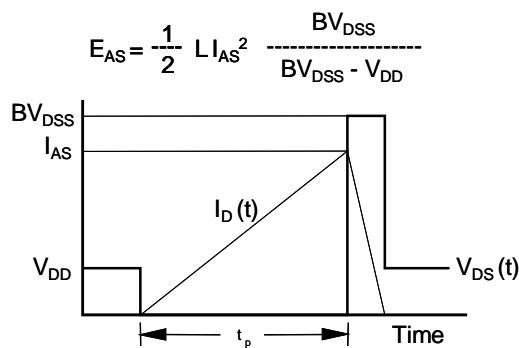
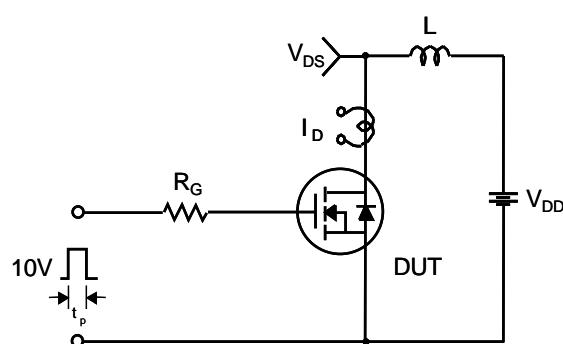
#### Gate Charge Test Circuit & Waveform



#### Resistive Switching Test Circuit & Waveforms



#### Unclamped Inductive Switching Test Circuit & Waveforms





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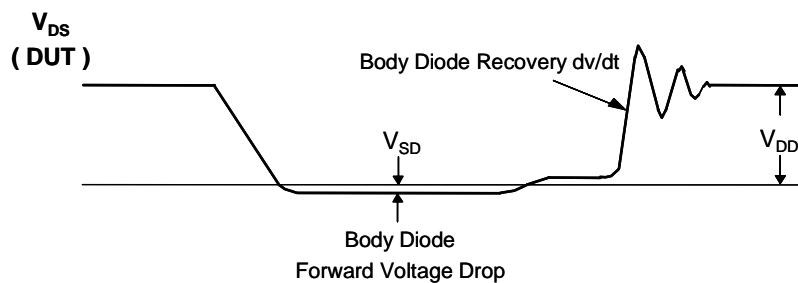
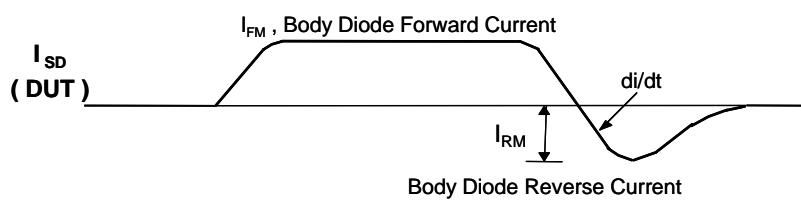
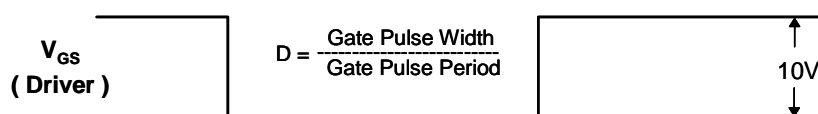
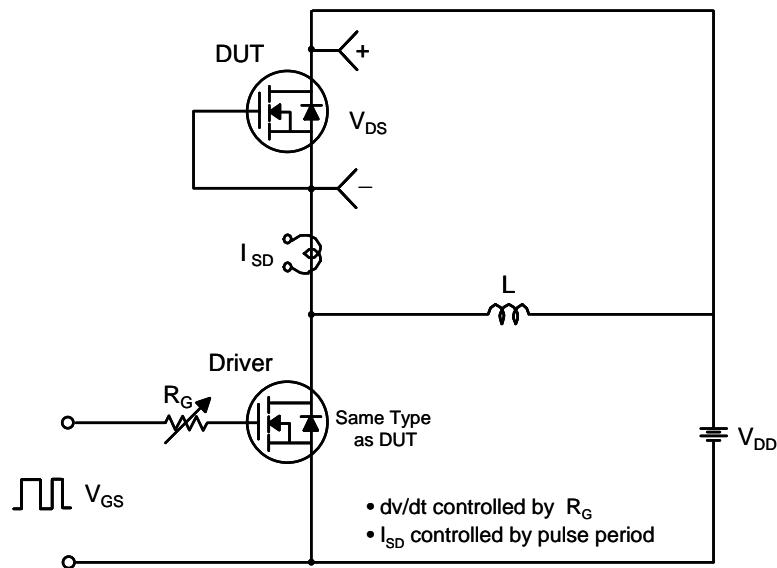
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Peak Diode Recovery dv/dt Test Circuit & Waveforms



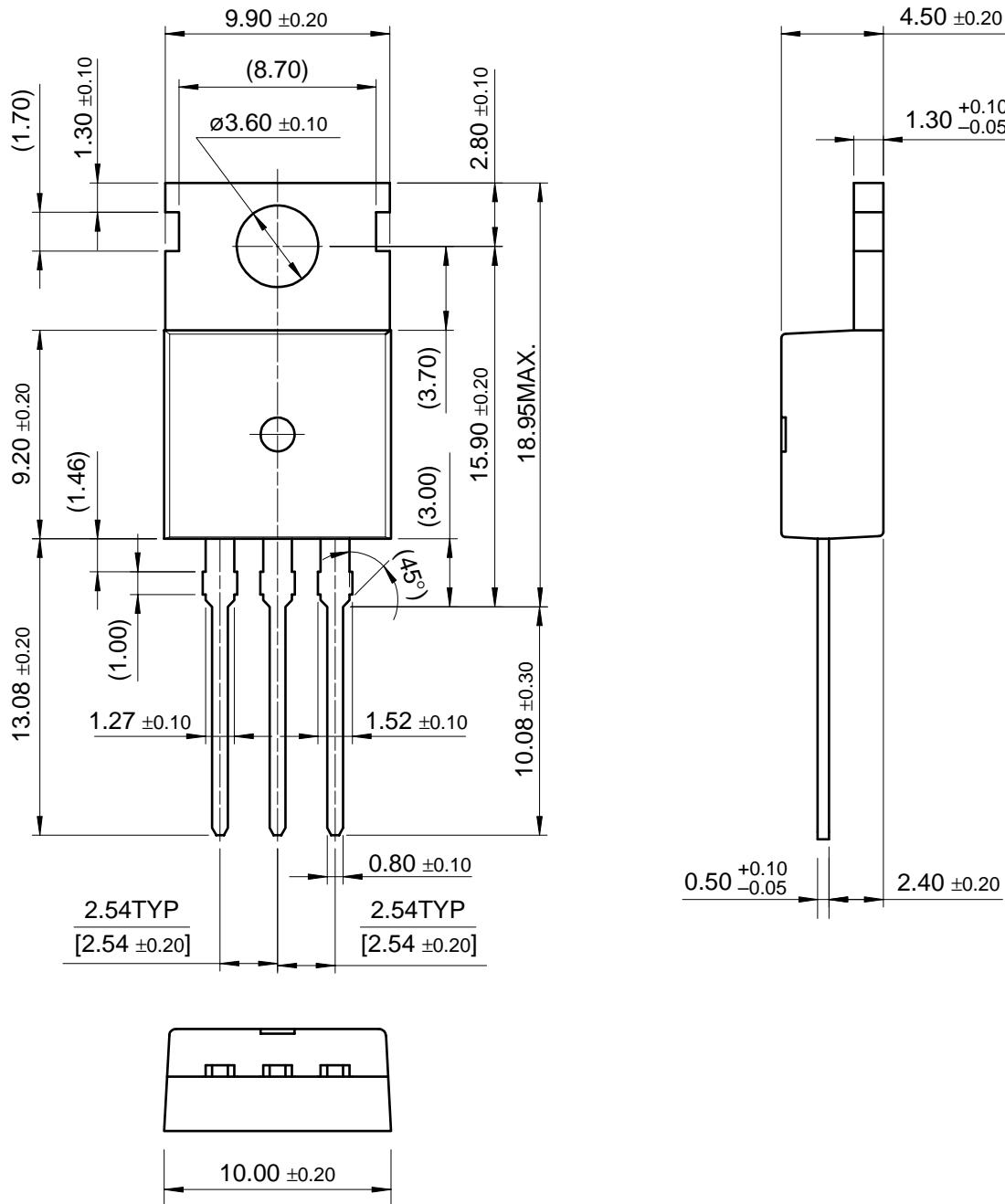


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## Package Dimensions

TO-220

FQPF8N80C/FQPF8N80C



Dimensions in Millimeters

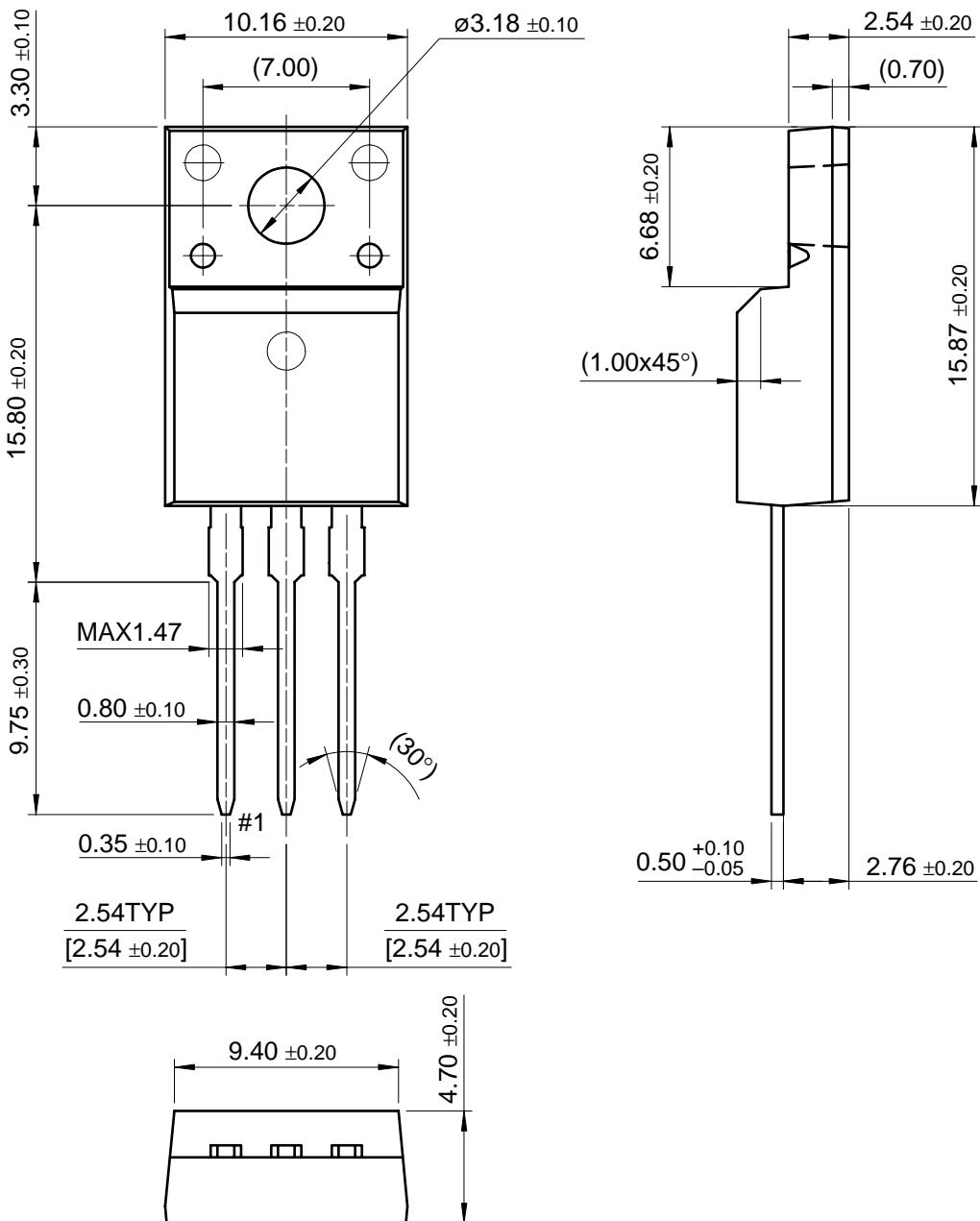


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## Package Dimensions (Continued)

FQPF8N80C/FQPF8N80C

### TO-220F



Dimensions in Millimeters



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